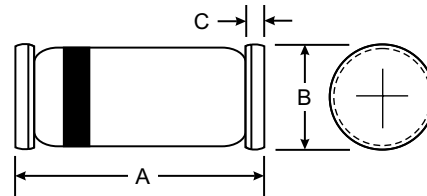


Features

- Low Forward Voltage Drop
- Guard Ring Construction for Transient Protection
- Fast Switching Time
- Low Reverse Capacitance



Mechanical Data

- Case: MiniMELF, Glass
- Terminals: Solderable per MIL-STD-202, Method 208
- Marking: Cathode Band Only
- Polarity: Cathode Band
- Weight: 0.05 grams (approx.)

MiniMELF		
Dim	Min	Max
A	3.30	3.70
B	1.30	1.60
C	0.28	0.50
All Dimensions in mm		

Maximum Ratings @ T_A = 25°C unless otherwise specified

Characteristic	Symbol	LL6263	Unit
Peak Repetitive Reverse Voltage	V _{RRM}	60	V
Working Peak Reverse Voltage	V _{RWM}		
DC Blocking Voltage	V _R		
RMS Reverse Voltage	V _{R(RMS)}	42	V
Forward Continuous Current (Note 1)	I _{FM}	15	mA
Non-Repetitive Peak Forward Surge Current	I _{FSM}	50	mA
@ t ≤ 1.0s		2.0	A
@ t = 10μs			
Power Dissipation (Note 1)	P _d	400	mW
Thermal Resistance, Junction to Ambient Air (Note 1)	R _{θJA}	375	K/W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +175	°C

Electrical Characteristics @ T_A = 25°C unless otherwise specified

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Maximum Forward Voltage Drop	V _{FM}	—	—	0.41 1.0	V	I _F = 1.0mA I _F = 15mA
Maximum Peak Reverse Current	I _{RM}	—	—	200	nA	V _R = 50V
Junction Capacitance	C _j	—	2.0	—	pF	V _R = 0V, f = 1.0MHz
Reverse Recovery Time	t _{rr}	—	1.0	—	ns	I _F = I _R = 5.0mA, I _{rr} = 0.1 x I _R , R _L = 100Ω

Note: 1. Valid provided that electrodes are kept at ambient temperature.

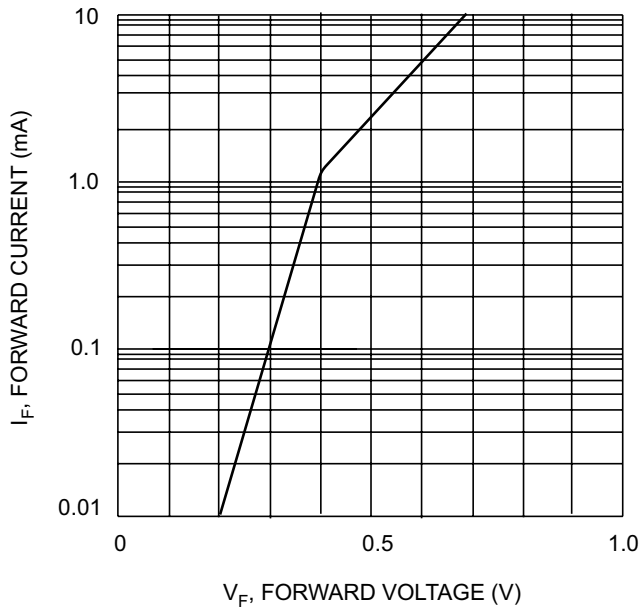


Fig. 1 Typical Forward Characteristic Variations for Primary Conduction

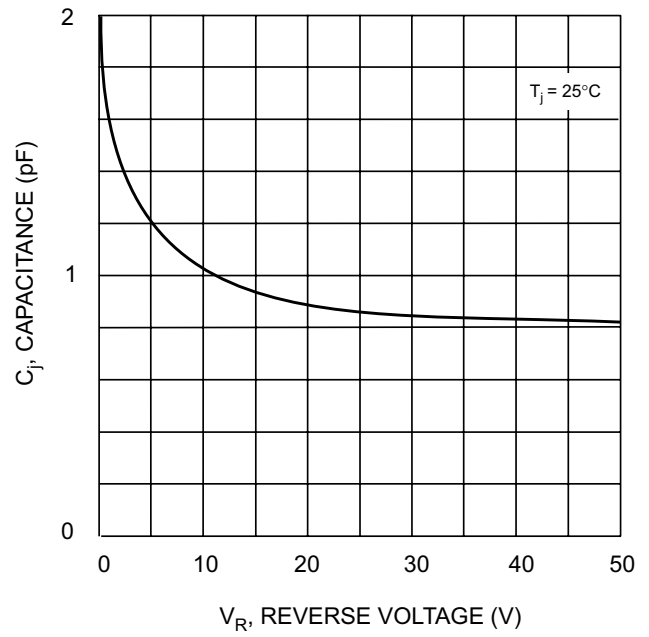


Fig. 2 Typ. Junction Capacitance vs Reverse Voltage

单击下面可查看定价，库存，交付和生命周期等信息

[>>Diodes Incorporated\(达达科技\(美台\)\)](#)